

FDD1600N10ALZ N-Channel PowerTrench[®] MOSFET 100 V, 6.8 A, 160 mΩ

Features

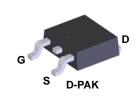
- $R_{DS(on)} = 124 \text{ m}\Omega \text{ (Typ.)} \otimes V_{GS} = 10 \text{ V}, I_D = 3.4 \text{ A}$
- $R_{DS(on)} = 175 \text{ m}\Omega \text{ (Typ.)} \otimes V_{GS} = 5.0 \text{ V}, I_D = 2.1 \text{ A}$
- Low Gate Charge (Typ.2.78 nC)
- Low C_{rss} (Typ. 2.04 pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- RoHS Compliant

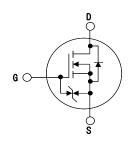
Description

This N-Channel MOSFET is produced using Fairchld Semiconductor[®]'s PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Consumer Appliances
- LED TV and Monitor
- Synchronous Rectification
- Uninterruptible Power Supply
- Micro Solar Inverter





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		FDD1600N10ALZ	Unit			
V _{DSS}	Drain to Source Voltage		100	V		
V _{GSS}	Gate to Source Voltage			±20	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		6.8	А	
	Drain Current	- Continuous ($T_C = 100^{\circ}C$)	uous ($T_{\rm C} = 100^{\rm o}{\rm C}$) 4.3			
I _{DM}	Drain Current	- Pulsed	13.6	А		
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	5.08	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	6.0	V/ns	
P _D	Dower Dissinction	(T _C = 25°C)	$(T_{\rm C} = 25^{\rm o}{\rm C})$		W	
	Power Dissipation	- Derate above 25°C		0.12	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

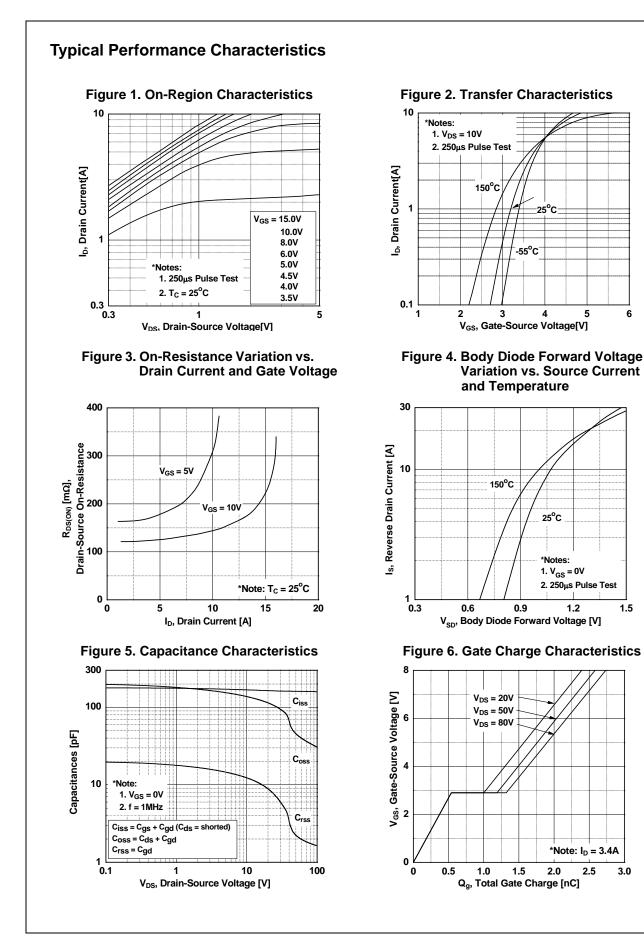
Thermal Characteristics

Symbol	Parameter	FDD1600N10ALZ	Unit
R_{\thetaJC}	Thermal Resistance, Junction to Case, Max	8.4	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max	87	-0/10

		Packag	е	Reel Size Tape Wid		pe Width	idth Quantity			
		D-PAK				16mm		2500		
Electrica	I Cha	racteristics T _C =2	25ºC unless o	otherwise no	oted					
Symbol		Parameter		1	est Condi	tions	Min.	Тур.	Max.	Uni
Off Charac	teristic	cs		1						
BV _{DSS}	Drain t	Drain to Source Breakdown Voltage			I _D = 250μA, V _{GS} = 0V				-	V
ABV _{DSS}	Breakdown Voltage Temperature				100	0.1		V/°(
ΔT_{J}	Coeffic	Coefficient			$I_D = 250\mu A$, Referenced to $25^{\circ}C$					v/ (
DSS	Zero G	ate Voltage Drain Curre	nt	$V_{DS} = 80V, V_{GS} = 0V$ $V_{DS} = 80V, V_{GS} = 0V, T_{C} = 125^{\circ}C$				-	1	μA
	Cata t	o Source Leakage Curre	nt	$V_{DS} = 80V$ $V_{GS} = \pm 20^{\circ}$			-	-	500 ±10	μA
GSS	Gale II	Source Leakage Curren	in .	VGS = ±20	$v, v_{\rm DS} = 0$	v	-	-	10	μΑ
On Charac	teristic	S								
V _{GS(th)}	Gate T	hreshold Voltage		$V_{GS} = V_{DS}$, Ι _D = 250μ	ιA	1.4	-	2.8	V
	Static	Drain to Source On Resi	etance	$V_{GS} = 10V$	′, I _D = 3.4A		-	124	160	mΩ
R _{DS(on)}	Static	Dialitito Source Off Resis	Slance	$V_{GS} = 5V, I_D = 2.1A$			-	175	375	1112.
9 _{FS}	Forwa	rd Transconductance		$V_{DS} = 10V$, I _D = 6.8A		-	19.6	-	S
Dynamic C	haract	eristics								
C _{iss}	Input C	nput Capacitance					-	169	225	pF
C _{oss}	Output	Capacitance			$V_{DS} = 50V, V_{GS} = 0V$		-	43	55	pF
C _{rss}	-	e Transfer Capacitance		f = 1MHz			-	2.04	-	pF
C _{oss(er)}		Related Output Capacit	ance	V _{DS} = 50V	, V _{GS} = 0V			85	-	pF
Q _{g(tot)}	Total G	ate Charge at 10V		V _{GS} = 10 \		V _{DD} = 50 V,	-	2.78	3.61	nC
Q _{g(tot)}	Total G	ate Charge at 5V		$V_{GS} = 5 V$				1.5	1.95	nC
Q _{gs}	Gate to	Source Gate Charge				-	0.72	-	nC	
Q _{gd}	Gate to	Drain "Miller" Charge					-	0.56	-	nC
V _{plateau}	Gate P	lateau Volatge		(Note 4) -	4.02	-	V	
Q _{sync}	Total G	I Gate Charge Sync.		V _{DS} = 0V, I _D = 3.4A (Note 5)) -	2.5	-	nC
Q _{oss}	Output	Output Charge $V_{DS} = 50V, V_{GS} = 0V$		-	5.2	-	nC			
Switching	Charac	cteristics								
t _{d(on)}	Turn-O	n Delay Time					-	7	24	ns
t _r		Turn-On Rise Time		$V_{DD} = 50V, I_D = 6.8A$			-	2	14	ns
t _{d(off)}		ff Delay Time		$V_{GS} = 10V, R_{GEN} = 4.7\Omega$		-	13	36	ns	
t _f	Turn-O	ff Fall Time) -	2	14	ns		
ESR	Equiva	Equivalent Series Resistance (G-S)			f = 1MHz			2.1	-	Ω
Drain-Sou	rce Dio	de Characteristics								
	- T	um Continuous Drain to S		E Forward C	urrent		-	-	6.8	Α
I _S I _{SM}	Maximum Pulsed Drain to Source Diode Fo						-	-	13.6	A
V _{SD}		Source Diode Forward		$V_{GS} = 0V,$			-	-	1.3	V
t _{rr}		e Recovery Time				V _{DS} = 50V	-	37	-	ns
Q _{rr}		e Recovery Charge		$dI_F/dt = 10$.03	-	42	-	nC
2. L = 1mH, I _{AS} =3 3. I _{SD} ≤ 6.8A, di/dt	8.18A, $R_G = 200A/\mu s$, pendent of 0	th limited by maximum junction t 25Ω, Starting T _J = 25°C V _{DD} ≤ BV _{DSS} , Starting T _J = 25°C Operating Temperature Typical C	;							

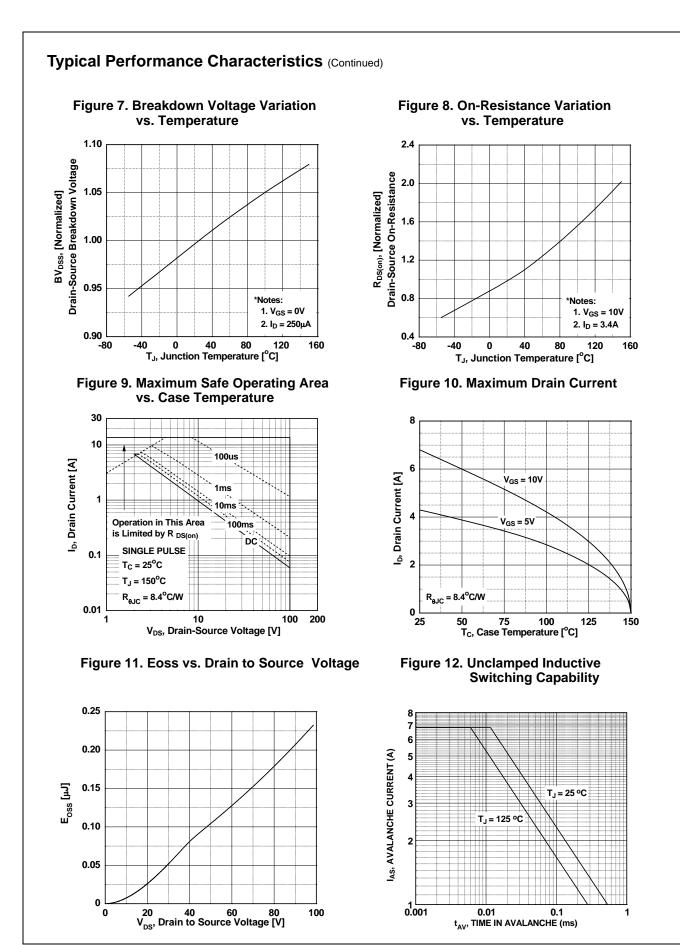
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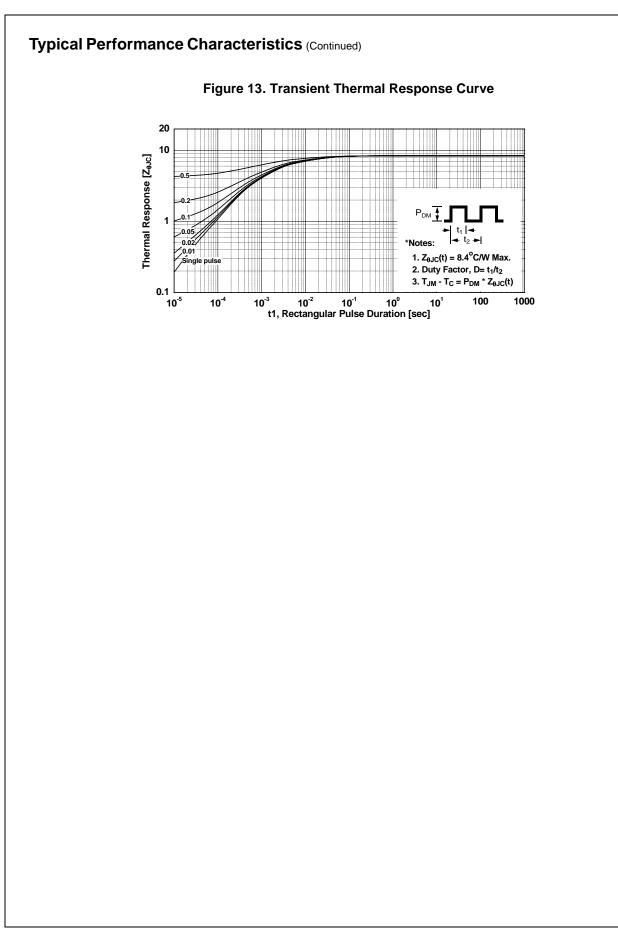


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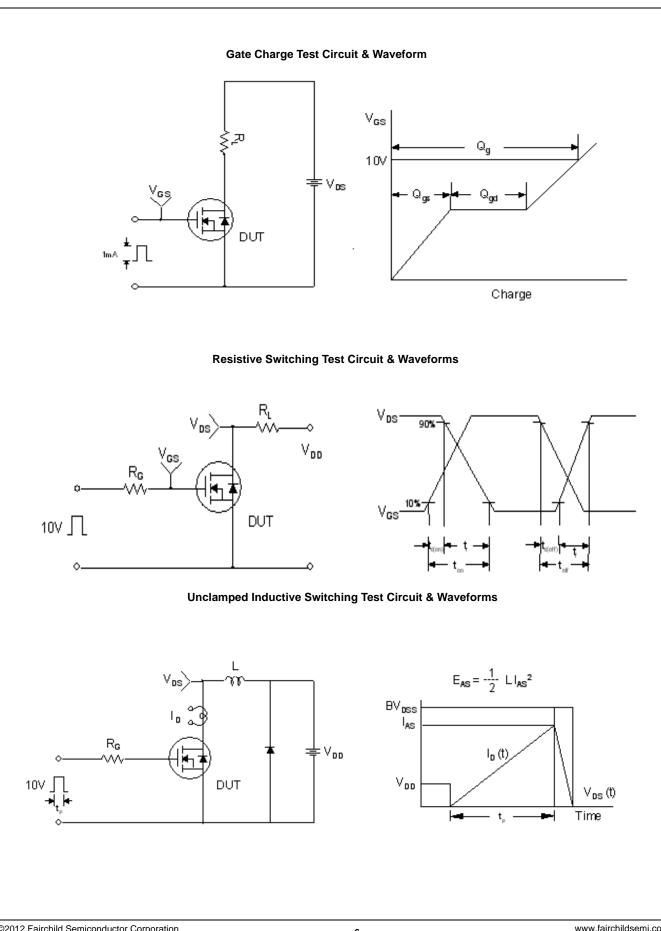
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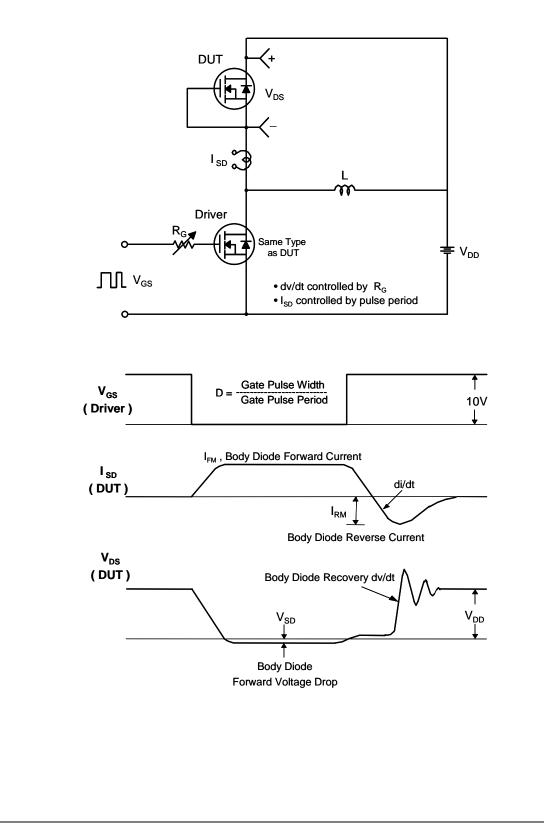


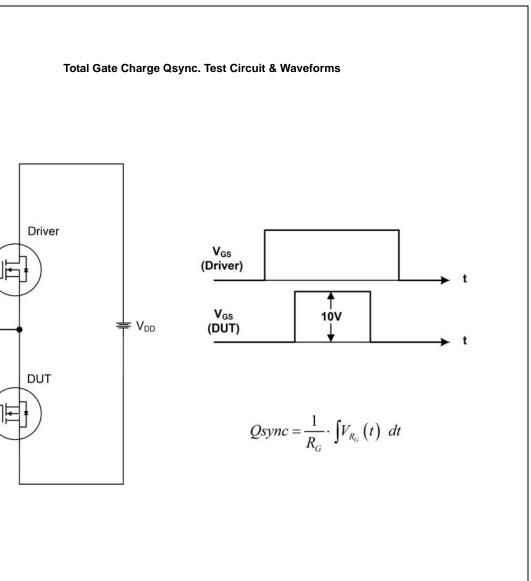
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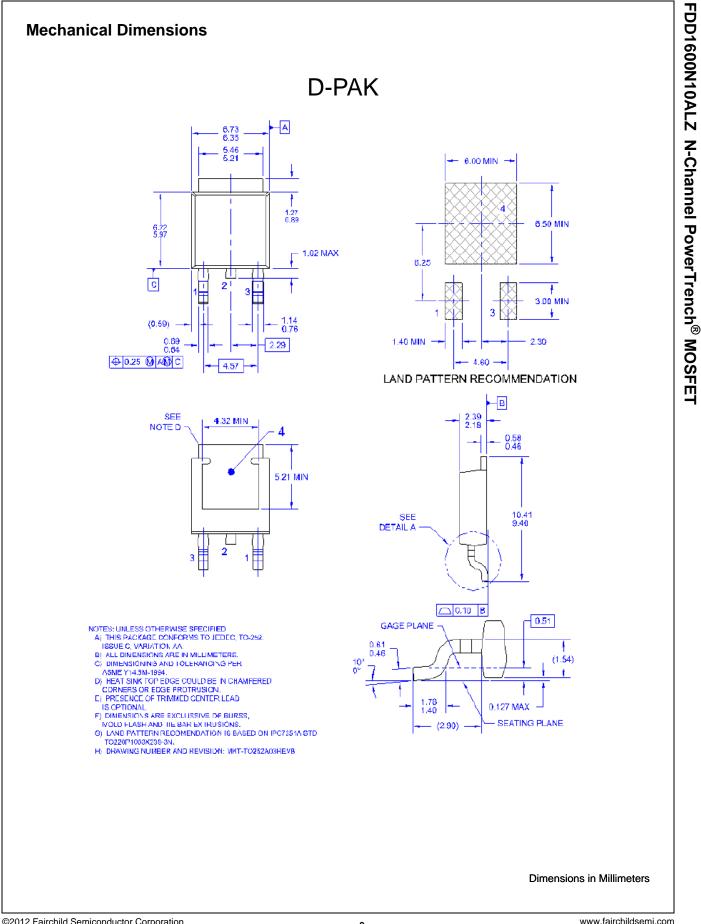




Vcc

R_G

10V ∏____





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